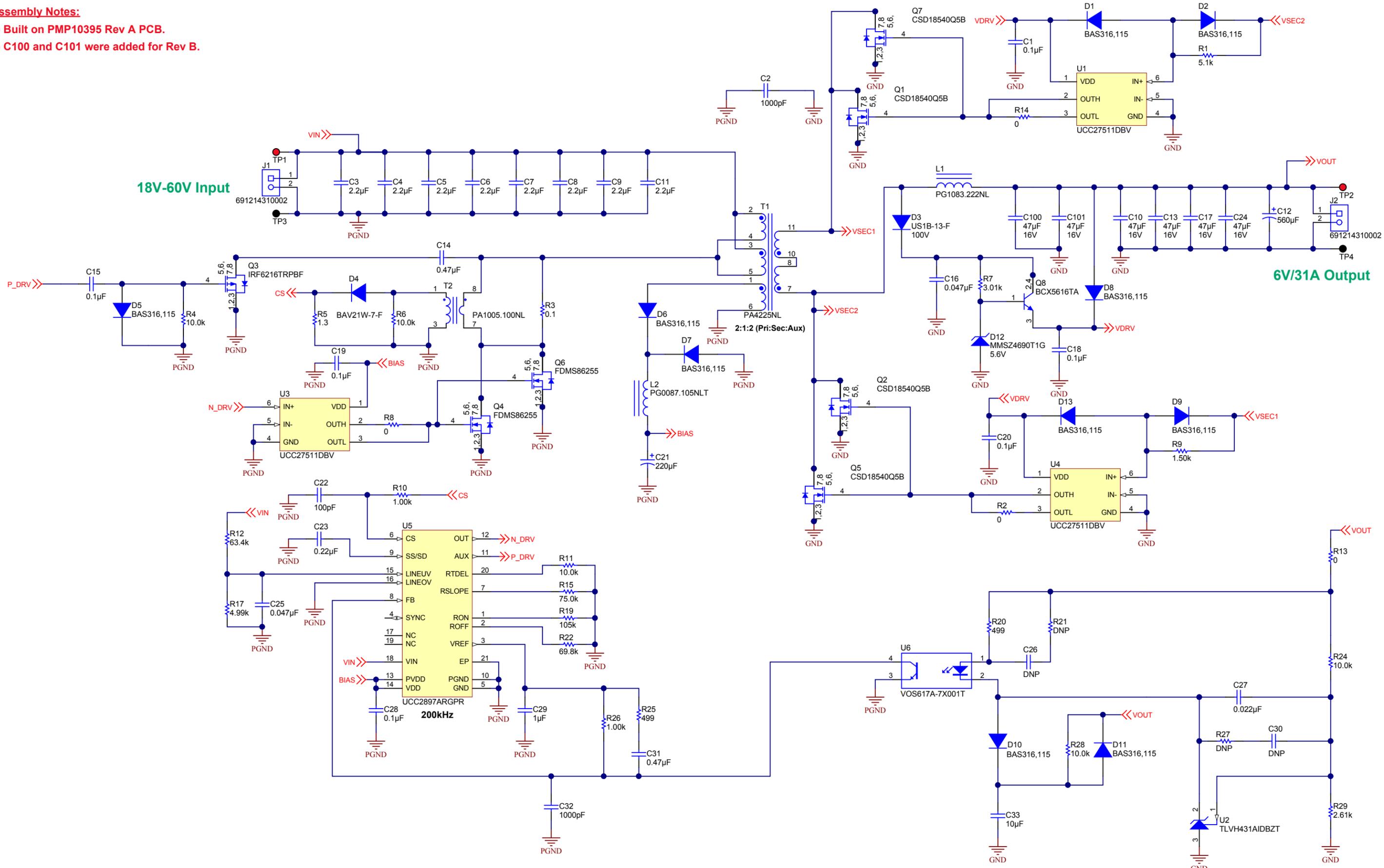


**Assembly Notes:**

- 1) Built on PMP10395 Rev A PCB.
- 2) C100 and C101 were added for Rev B.



PCB Number: PMP10395  
PCB Rev: A



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Number: PMP10395	Rev: B	Designed for:	Mod. Date: 9/25/2014
SVN Rev: Version control disabled		Project Title: 18-60VDCin, 6V/31A Active Clamp Forward	
Drawn By:		Sheet Title:	Sheet: 1 of 1
Engineer: B King		Assembly Variant: 001	Size: B
		File: PMP10395_REV.B.SchDoc	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>
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